

## Declaration, Power of Attorney, and Petition

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **Method for Fabricating Nanometer Gate in Semiconductor Device Using Thermally Reflowed Resist Technology**

(check one)  is attached hereto.  was filed on ..... as Application Serial No. ..... and was amended on ..... (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

## Prior Foreign Application(s)

(Number)	(Country)	(Day/month/year filed)	Priority claimed
092112920	Taiwan, R.O.C.	13/05/03	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
			<input type="checkbox"/> Yes <input type="checkbox"/> No
			<input type="checkbox"/> Yes <input type="checkbox"/> No

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.) (Filing date) (Status) (Patented, pending, abandoned)

(Application Serial No.) (Filing date) (Status) (Patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

And I hereby appoint

The practitioners listed on Schedule A

my attorney with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.

Wherefore I pray that Letters Patent be granted to me for the invention or discovery described and claimed in the foregoing specification and claims, and I hereby subscribe my name to the foregoing specification and claims, declaration, power of attorney, and this petition.

Full name of sole or first inventor..... Edward Y. Chang.....

Inventor's signature..... Edward Y. Chang..... Date..... Sept. 9. 2003.....

Residence..... Taiwan, R.O.C.

Citizenship..... Taiwan, R.O.C.

Post Office Address..... 1F, No. 38, Hubin 2nd Rd., Science Park, Hsinchu City, Taiwan, R.O.C.

Full name of second joint inventor, if any..... Huang-Ming Lee.....

Second Inventor's signature..... Huang Ming Lee..... Date..... 9. Sep. 2003.....

Residence..... Taiwan, R.O.C.

Citizenship..... Taiwan, R.O.C.

Post Office Address..... No. 18-2, Shuanghan Village, Lioujiao Township, Chiayi County, Taiwan, R.O.C.

Full name of third joint inventor, if any.....

Third Inventor's signature..... Date.....

Residence.....

Citizenship.....

Post Office Address.....

Full name of fourth joint inventor, if any.....

Fourth Inventor's signature..... Date.....

Residence.....

Citizenship.....

Post Office Address.....

Full name of fifth joint inventor, if any.....

Fifth Inventor's signature..... Date.....

Residence.....

Citizenship.....

Post Office Address.....

(Supply similar information and signature for third and subsequent joint inventors)

## Schedule A

Registered practitioner(s) name/registration number listed below

Name	Registration Number	Name	Registration Number
Andrew F. Abramson	52,538	Duncan A. Greenhalgh	38,678
Steven M. Bauer	31,481	William R. Haulbrook	53,002
Mark L. Beloborodov	50,773	Ira V. Heffan	41,059
John V. Bianco	36,748	Douglas J. Kline	35,574
Robert S. Blasi	50,389	M. Brad Lawrence	47,210
Michael H. Brodowski	41,640	William A. Meunier	41,193
Jennifer A. Camacho	43,526	Thomas C. Meyers	36,989
Joseph A. Capraro, Jr.	36,471	Jennifer G. Moitoso	51,752
Fangli Chen	51,551	Ronda P. Moore	44,244
Christopher H. Chung	50,351	Jeremy P. Oczek	50,794
John J. Cotter	38,116	Jamie H. Rose	45,054
James C. De Vellis	52,814	Christopher W. Stamos	35,370
Robert V. Donahoe	46,667	Diana M. Steel	43,153
Brian A. Fairchild	48,645	Robert J. Tosti	35,393
James E. Fajkowski	54,089	Thomas A. Turano	35,722
Jason P. Fiorillo	52,892	Natasha C. Us	44,381
John V. Forcier	42,545	Christine C. Vito	39,061
Steven J. Frank	33,497	Daniel A. Wilson	45,508
Kia L. Freeman	47,577	Gerald E. Worth	45,238
Brian M. Gaff	44,691		
Edward A. Gordon	54,130		

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